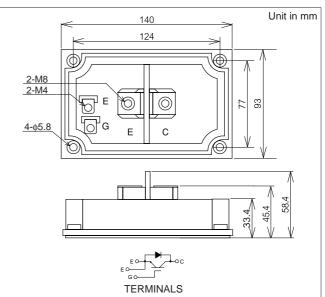
# MBN600C33A

Silicon N-channel IGBT

OUTLINE DRAWING

#### FEATURES

- \* High thermal fatigue durability. (delta Tc=70°C,N>20,000cycles)
- \* low noise due to built-in free-wheeling diode - ultra soft fast recovery diode(USFD).
- \*High speed,low loss IGBT module.
- \*Low driving power due to low input capacitance MOS gate.
- \*High reliability, high durability module.
- \* Isolated head sink (terminal to base).



Weight: 890 (g)

Item		Symbol	Unit	MBN600C33A		
Collector Emitter Vol	Itage	V <sub>CES</sub>	V	3,300		
Gate Emitter Voltage	9	V <sub>GES</sub>	V	±20		
Collector Current	DC	lc	Α	600		
	1ms	I <sub>CP</sub>	A	1,200		
Forward Current	DC	lF	٨	600		
	1ms	I <sub>FM</sub>	Α	1,200		
Collector Power Diss	sipation	Pc	W	5,800		
Junction Temperatur	е	Tj	°C	-40 ~ +125		
Storage Temperatur	е	T <sub>stg</sub>	°C	-40 ~ +125		
Isolation Voltage		VISO	V <sub>RMS</sub>	5,400(AC 1 minute)		
Screw Torque	Terminals(M4/M8)	-	N.m	2/10 (1)		
	Mounting(M5)	-		2.8 (2)		

#### ABSOLUTE MAXIMUM RATINGS (Tc=25°C)

Notes: (1)Recommended Value 1.8±0.2/9±1N.m

(2)Recommended Value 2.6±0.2N.m

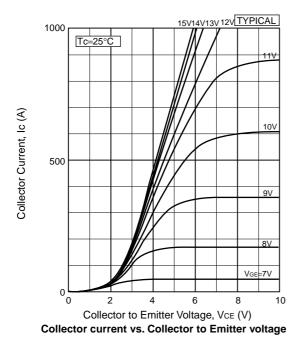
#### CHARACTERISTICS (Tc=25°C)

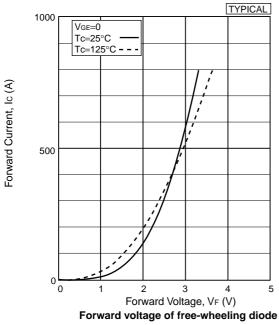
Item		Symbol	Unit	Min.	Тур.	Max.	Test Conditions
Collector Emitter Cut-Off Current		I <sub>CES</sub>	mA	-	-	6.0	V <sub>CE</sub> =3,300V,V <sub>GE</sub> =0V
Gate Emitter Leakage Current		IGES	nA	-	-	±300	V <sub>GE</sub> =±20V,V <sub>CE</sub> =0V
Collector Emitter Saturation Voltage		V <sub>CE(sat)</sub>	V	-	4.5	5.5	I <sub>C</sub> =600A,V <sub>GE</sub> =15V
Gate Emitter Threshold Voltage		V <sub>GE(TO)</sub>	V	4.0	5.5	7.0	V <sub>CE</sub> =10V, I <sub>C</sub> =600mA
Input Capacitance		Cies	nF	-	75	-	V <sub>CE</sub> =10V,V <sub>GE</sub> =0V,f=100KHz
Switching Times	Rise Time	tr		-	1.9	3.0	Vcc=1,650V,Ic=600A
	Turn On Time	t <sub>on</sub>	μS	-	2.6	4.0	L=150nH
	Fall Time	t <sub>f</sub>		-	2.4	3.2	$R_{G}=6.8\Omega \qquad (3)$
	Turn Off Time	t <sub>off</sub>		-	4.1	6.0	V <sub>GE</sub> =±15V Tc=125°C
Peak Forward Voltage Drop		V <sub>FM</sub>	V	-	3.0	4.0	-Ic=600A,V <sub>GE</sub> =0V
Reverse Recovery Time		t <sub>rr</sub>	μS	-	0.7	1.4	Vcc=1,650V,-Ic=600A,L=150nH,
							Tc=125°C (4)
Thermal Impedance	IGBT	Rth(j-c)	°C/W	-	-	0.017	Junction to case
	FWD	Rth(j-c)		-	-	0.033	

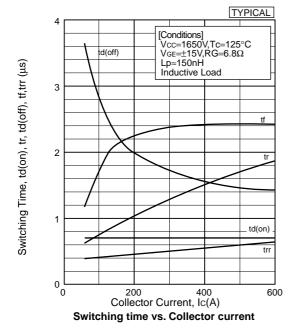
Notes:(3)  $R_G$  value is the test condition's value for decision of the switching times, not recommended value. Determine the suitable  $R_G$  value after the measurement of switching waveforms

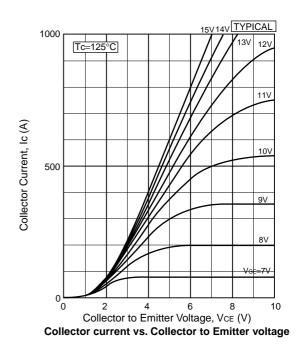
(overshoot voltage,etc.)with appliance mounted.

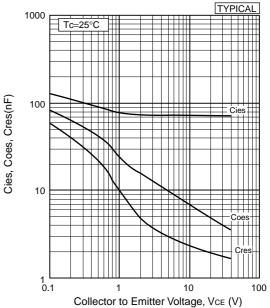
(4) Counter arm IGBT  $V_{GE}$ =-15V



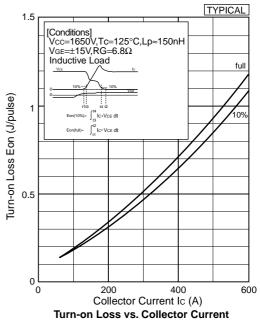




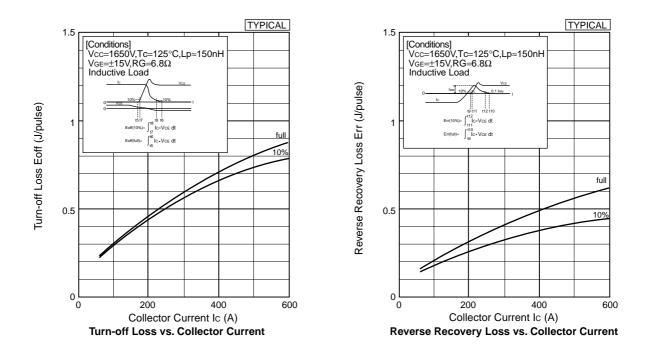




Capacitance vs. Collector to Emitter Voltage



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